

RF/Microwave Capacitors

RF/Microwave Multilayer Capacitors (MLC)

100E Series Porcelain High RF Power Multilayer Capacitors



GENERAL DESCRIPTION

KYOCERA AVX, the industry leader, offers new improved ESR/ESL performance for the 100 E Series RF Capacitors. This high Q multilayer capacitor is ultra-stable under high RF current and voltage applications. High density porcelain construction provides a rugged, hermetic package. KYOCERA AVX offers an encapsulation option for applications requiring extended protection against arc-over and corona.

FUNCTIONAL APPLICATIONS

- Bypass
- Impedance Matching
- Coupling
- DC Blocking
- Tuning

CIRCUIT APPLICATIONS

- HF/RF Power Amplifiers
- Plasma Chambers
- Transmitters
- Medical (MRI coils)
- Antenna Tuning

ENVIRONMENTAL CHARACTERISTICS

Thermal Shock	Mil-STD-202, Method 107, Condition A
Moisture Resistance	Mil-STD-202, Method 106
Low Voltage Humidity	Mil-STD-202, Method 103, condition A, with 1.5 VDC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours
Life Test	MIL-STD-202, Method 108, for 2000 hours, at 125°C. Voltage applied. 200% of WVDC for capacitors rated at 500 volts DC or less. 120% of WVDC for capacitors rated at 1250 volts DC or less. 100% of WVDC for capacitors rated above 1250 volts DC
Termination Styles	Available in various surface mount and leaded styles. See Mechanical Configurations
Terminal Strength	Terminations for chips and pellets withstand a pull of 10 lbs. min., 25 lbs. typical, for 5 seconds in direction perpendicular to the termination surface of the capacitor.

FEATURES

- Case E Size (.380" x .380")
- Capacitance Range 1pF to 5100pF
- Extended WVDC up to 7200 VDC
- Low ESR/ESL
- High Q
- High RF Power
- Ultra-Stable Performance
- High RF Current/Voltage
- Available with Encapsulation Option*

* For leaded styles only

PACKAGING OPTIONS



Tape & Reel



Tray
(96 pcs)



ELECTRICAL SPECIFICATIONS

Temperature Coefficient (TCC)	90 ± 30 PPM/°C
Capacitance Range	1 pF to 5100 pF
Operating Temperature	-55°C to +125°C*
Quality Factor	Greater than 10,000 (1 pF to 1000 pF) @ 1 MHz. Greater than 10,000 (1100 pF to 5100 pF) @ 1 KHz.
Insulation Resistance (IR)	1 pF to 5100 pF 10 ⁵ Megohms min. @ 25°C at 500 VDC 10 ⁴ Megohms min. @ 125°C at 500 VDC
Working Voltage (WVDC)	See Capacitance Values table
Dielectric Withstanding Voltage (DWV)	250% of WVDC for capacitors rated at 500 volts DC or less for 5 seconds. 150% of WVDC for capacitors rated at 1250 volts DC or less for 5 seconds. 120% of WVDC for capacitors rated above 1250 Volts DC for 5 seconds
Aging Effects	None
Piezoelectric Effects	None
Capacitance Drift	± (0.02% or 0.02 pF), whichever is greater
Retrace	Less than ±(0.02% or 0.02 pF), whichever is greater.

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MECHANICAL CONFIGURATION

Series & Case Size	Term. Code	Case Size & Type	Outline W/T is a Termination Surface	Body Dimensions inches (mm)			Lead and Termination Dimensions and Material		Pkg Type & Qty	Pkg Code	
				Length (L)	Width (W)	Thickness (T)	Overlap (Y)	Materials			
100E	W	E Solder Plate		.380+.015-.010 (9.65+0.38-0.25)	.380 ±.010 (9.65 ±0.25)	.170 (4.32) max.	.040 (1.02) max.	Tin/Lead, Solder Plated over Nickel Barrier Termination	T&R, 250 pcs Tray, 24 or 96 pcs	T J24 J96	
100E	P	E Pellet		.380+.040-.010 (9.65+1.02-0.25)				Heavy Tin/Lead Coated, over Nickel Barrier Termination	T&R, 250 pcs Tray, 24 or 96 pcs	T J24 J96	
100E	T	E Solderable Nickel		.380+.015-.010 (9.65+0.38-0.25)				RoHS Compliant Tin Plated over Nickel Barrier Termination	T&R, 250 pcs Tray, 24 or 96 pcs	T J24 J96	
100E	MS	E Microstrip		.380+.035-.010 (9.65+0.89-0.25)			N/A	N/A	High Purity Silver Leads L _L = .750 (19.05) min W _L = .350 ±.010 (8.89 ±0.25) T _L = .010 ±.005 (0.25 ±0.13) Leads are Attached with High Temperature Solder.	Tray, 16 or 32 pcs	J16 J32
100E	AR	E Axial Ribbon							Tray, 16 or 32 pcs	J16 J32	
100E	AW	E Non-Mag Axial Wire							Box, 20 pcs	B20	
100E	RW	E Non-Mag Radial Wire							Tray, 16 or 64 pcs	J16 J64	

Custom lead styles and lengths are available; consult factory. All leads are high purity silver attached with high temperature solder and are **RoHS** compliant.

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				Length (L)	Width (W)	Thickness (T)	Overlap (Y)	Materials			
100E	WN	Non-Mag Solder Plate		.380+.015-.010 (9.65+0.38-0.25)	.380 ±.010 (9.65 ±0.25)	.170 (4.32) max.	.040 (1.02) max.	Tin/Lead, Solder Plated over Non-Magnetic Barrier Termination	T&R, 250 pcs Tray, 24 or 96 pcs	T J24 J96	
100E	PN	Non-Mag Pellet		.380+.040-.010 (9.65+1.02-0.25)				Heavy Tin/Lead Coated, over Non-Magnetic Barrier Termination	T&R, 250 pcs Tray, 24 or 96 pcs	T J24 J96	
100E	TN	Non-Mag Solderable Barrier		.380+.015-.010 (9.65+0.38-0.25)				RoHS Compliant Tin Plated over Non-Magnetic Barrier Termination	T&R, 250 pcs Tray, 24 or 96 pcs	T J24 J96	
100E	MN	Non-Mag Microstrip		.380+.035-.010 (9.65+0.89-0.25)			N/A	N/A	High Purity Silver Leads $L_L = .750$ (19.05) min $W_L = .350 \pm .010$ (8.89 ±0.25) $T_L = .010 \pm .005$ (0.25 ±0.13) Leads are Attached with High Temperature Solder.	Tray, 16 or 32 pcs	J16 J32
100E	AN	Non-Mag Axial Ribbon							Silver-plated Copper Leads Dia. = .032 ±.002 (.813 ±.051) $L_L = 2.25$ (57.2) min.	Tray, 16 or 32 pcs	J16 J32
100E	BN	Non-Mag Axial Wire								Silver-plated Copper Leads Dia. = .032 ±.002 (.813 ±.051) $L_L = 1.0$ (25.4) min.	Box, 20 pcs
100E	RN	Non-Mag Radial Wire									Tray, 16 or 64 pcs

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SUGGESTED MOUNTING PAD DIMENSIONS

Horizontal Electrode Orientation

Mount Type	Case E				
	Pad Size	A Min.	B Min.	C Min.	D Min.
Horizontal Mount	Normal	.405	.050	.325	.425
	High Density	.385	.030	.325	.385

Dimensions are in inches.

PERFORMANCE DATA

